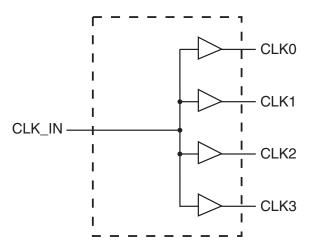
Low Skew Output Buffer

General Description

The **ICS9112-26** is a high performance, low skew, low jitter clock driver. It is designed to distribute high speed clocks in PC systems operating at speeds from 0 to 133 MHz.

The **ICS9112-26** comes in an eight pin 150 mil SOIC package. It has four output clocks.

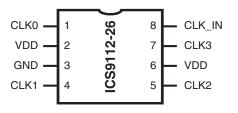
Block Diagram



Features

- Frequency range 0 133 MHz (3.3V)
- Less than 200 ps Jitter between outputs
- Skew controlled outputs
- Skew less than 250 ps between outputs
- Available in 8 pin 150 mil SOIC & 173 mil TSSOP packages.
- $3.3V \pm 10\%$ operation

Pin Configuration



8 pin SOIC & TSSOP

Pin Descriptions

PIN NUMBER	PIN NAME	ТҮРЕ	DESCRIPTION
1	CLK0 ¹	OUT	Buffered clock output
2,6	VDD	PWR	Power Supply (3.3V)
3	GND	PWR	Ground
4	CLK1 ¹	OUT	Buffered clock output
5	CLK2 ¹	OUT	Buffered clock output
7	CLK3 ¹	OUT	Buffered clock output
8	CLK_IN	IN	Input reference frequency.

Notes:

1. Weak pull-down on all outputs

Absolute Maximum Ratings

Supply Voltage	7.0 V
Logic Inputs	GND –0.5 V to V_{DD} +0.5 V
Ambient Operating Temperature	0° C to +70°C
Storage Temperature	-65°C to +150°C

Stresses above those listed under *Absolute Maximum Ratings* may cause permanent damage to the device. These ratings are stress specifications only and functional operation of the device at these or any other conditions above those listed in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect product reliability.

Electrical Characteristics at 3.3V

 $T_A = 0$ - 70C; Supply Voltage $V_{DD} = 3.3 \text{ V} + -5\%$ (unless otherwise stated)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
		V_{DD} = min to max, I_{OH} = -1 mA	V _{DD} - 0.2	3.3		V
High-level Output Voltage	V _{OH}	$V_{DD} = 3V, I_{OH} = -24 \text{ mA}$	2	2.9		V
		$V_{DD} = 3V, I_{OH} = 12 \text{ mA}$	2.4	3.1		V
		V_{DD} = min to max, I_{OH} = 1 mA		0.0055	0.2	V
Low-level Output Voltage	V _{OL}	$V_{DD} = 3V, I_{OH} = 24 \text{ mA}$	0.28	0.8	V	
		$V_{DD} = 3V, I_{OH} = 12 \text{ mA}$		0.14	0.55	V
High lovel Input Cument	т	$V_{DD} = 3V, V_O = 1V$		-61	-50	
High-level Input Current	I _{OH}	$V_{DD} = 3.3V, V_{O} = 1.65V$		-77		
Low lovel Input Cumont	т	$V_{DD} = 3V, V_O = 2V$	60	103		
Low-level Input Current	I _{OL}	$V_{DD} = 3.3V, V_{O} = 1.65V$		111		
Input Current	II	$V = V_0 \text{ or } V_{DD}$	-5		5	μΑ
Input Capacitance ¹	CI	$V_{DD} = 3.3V, V_I = 0V \text{ or } 3.3V$		3		pF
Output Capacitance ¹	CO	$V_{DD} = 3.3V, V_I = 0V \text{ or } 3.3V$		3.2		pF
Supply current	I _{DD}	REF = 0 MHz		22	50	μA
Supply current	¹ DD	Unloaded outputs at 66.67 MHz		25	40	mA

1. Guaranteed by design, not 100% tested in production.

Switching Characteristics at 3.3V

 $T_A = 0$ - 70C; Supply Voltage $V_{DD} = 3.3 \text{ V} + -5\%$ (unless otherwise stated)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS	
Low-to-high Propagation Delay ¹	t _{PLH}	$V_0 = V_{DD}/2$	4	5.6	7	ns	
High-to-low Propagation Delay ¹	t _{PHL}	$V_{O} = V_{DD}/2$	4	5.2	7	ns	
Output Skew Window ¹	T _{sk} (O)	$V_{O} = V_{DD}/2$		50	100	ps	
Process Skew ¹	T _{sk} (PR)	$V_{O} = V_{DD}/2$			0.5	ps	
CLKIN High Time ¹	Thigh 66 MHz 133 MHz	66 MHz	6			ns	
		3			115		
CLKIN Low Time ¹	т	66 MHz	6			ns	
CERIN Low Time	T _{low}	133 MHz	3				
Output Rise Slew Rate ¹	T _r	0.3 to 0.6 V_{DD}	2	3.6	5	V/ns	
Output Rise Slew Rate ¹	T _f	0.3 to 0.6 V_{DD}	2	3.2	5	V/ns	

1. Guaranteed by design, not 100% tested in production.

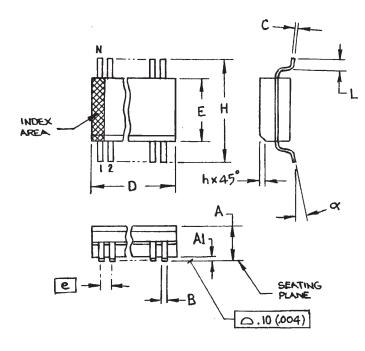
Notes:

1. Guaranteed by design and characterization. Not subject to 100% test.

2. CLK_IN input has a threshold voltage of 1.4V

3. All parameters expected with loaded outputs

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SYMBOL	In Millimeters COMMON DIMENSIONS		In Inches COMMON DIMENSIONS		
	MIN	MAX	MIN	MAX	
А	1.35	1.75	.0532	.0688	
A1	0.10	0.25	.0040	.0098	
В	0.33	0.51	.013	.020	
С	0.19	0.25	.0075	.0098	
D	SEE VARIATIONS		SEE VARIATIONS		
E	3.80	4.0	.1497	.1574	
е	1.27 E	BASIC	0.050 BASIC		
Н	5.80	6.20	.2284	.2440	
h	0.25	0.50	.010	.020	
L	0.40	1.27	.016	.050	
Ν	SEE VARIATIONS		SEE VAR	RIATIONS	
α	0°	8°	0°	8°	

VARIATIONS

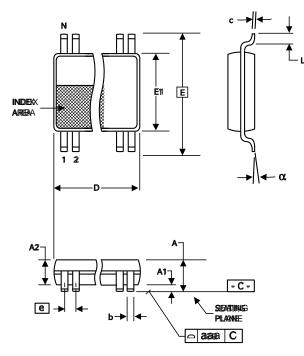
Ν	D mm.		D (inch)		
	MIN	MAX	MIN	MAX	
8	4.80	5.00	.1890	.1968	



Ordering Information

9112yM-<u>2</u>6LFT

Example: XXXX Y M - PPP LFT Designation for tape and reel packaging Lead Free, RoHS Compliant (Optional) Pattern Number (2 or 3 digit number for parts with ROM code patterns) Package Type M=SOIC Revision Designator (will not correlate with datasheet revision) Device Type (consists of 3 or 4 digit numbers)



4.40 mm.	Body, 0.65 mm. pitch TSSOP
(173 mil)	(0.0256 mil)

SYMBOL	In Millin COMMON D		In Inches COMMON DIMENSIONS	
	MIN	MAX	MIN	MAX
А	-	1.20	-	.047
A1	0.05	0.15	.002	.006
A2	0.80	1.05	.032	.041
b	0.19	0.30	.007 .012	
С	0.09	0.20	.0035	.008
D	SEE VARIATIONS		SEE VARIATIONS	
E	6.40 E	BASIC	0.252 BASIC	
E1	4.30	4.50	.169	.177
е	0.65	BASIC	0.0256 BASIC	
L	0.45	0.75	.018	.030
Ν	SEE VARIATIONS		SEE VAR	RIATIONS
α	0°	8°	0°	8°
aaa	-	0.10	-	.004

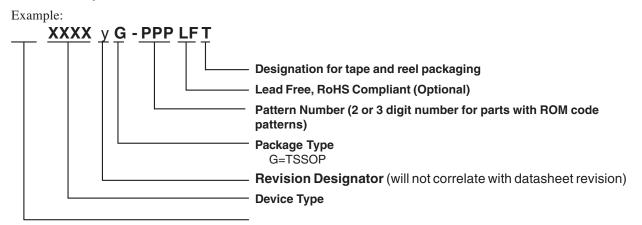
VARIATIONS

N	D mm.		D (inch)		
	MIN	MAX	MIN	MAX	
8	2.90	3.10	.114	.122	
			MO-153 JEDEC	7/6/00 Rev B	

Doc.# 10-0038

Ordering Information

9112yG-<u>2</u>6LFT



Revision History

Rev.	Issue Date	Description	
С	04/17/07	Added LF to Ordering Information.	-
D	05/14/07	Updated Ordering Information.	3-4

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